

SANYO Semiconductors DATA SHEET

CPH5870

MOSFET: N-Channel Silicon MOSFET

SBD: Schottky Barrier Diode

General-Purpose Switching Device Applications

Features

- Composite type with a N-channel sillicon MOSFET and a schottky barrier diode contained in one package facilitating high-density mounting.
- · [MOSFET]
 - · Low ON-resistance
 - · Ultrahigh-speed switching
 - 2.5V drive.
- · [SBD]
 - Short reverse recovery time (t_{rr} max=10ns).
 - · Low forward voltage (VF max=0.55V).

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
[MOSFET]				
Drain-to-Source Voltage	VDSS		60	V
Gate-to-Source Voltage	VGSS		±10	V
Drain Current (DC)	ID		1.8	А
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	7.2	Α
Allowable Power Dissipation	PD	When mounted on ceramic substrate (600mm²X0.8mm) 1unit	0.9	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +125	°C

Marking: YY Continued on next page.

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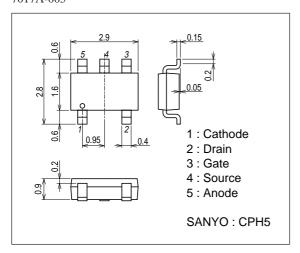
Parameter	Symbol	Conditions	Ratings	Unit						
[SBD]										
Repetitive Peak Reverse Voltage	VRRM		50	V						
Nonrepetitive Peak Reverse Surge Voltage	VRSM		55	V						
Average Output Current	lo		800	mA						
Surge Forward Current	IFSM	50Hz sine wave, 1 cycle	5	Α						
Junction Temperature	Tj		-55 to +125	°C						
Storage Temperature	Tstg		-55 to +125	°C						

Electrical Characteristics at Ta=25°C

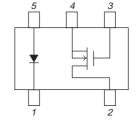
Parameter	Symbol	Conditions	Ratings			Unit
Parameter			min	typ	max	Unit
[MOSFET]					•	
Drain-to-Source Breakdown Voltage	V(BR)DSS	I _D =1mA, V _G S=0V	60			V
Zero-Gate Voltage Drain Current	IDSS	V _{DS} =60V, V _{GS} =0V			1	μΑ
Gate-to-Source Leakage Current	IGSS	V _{GS} =±8V, V _{DS} =0V			±10	μΑ
Cutoff Voltage	V _{GS} (off)	V _{DS} =10V, I _D =1mA	0.4		1.3	V
Forward Transfer Admittance	yfs	V _{DS} =10V, I _D =1A	1.8	3.6		S
Static Drain-to-Source On-State Resistance	R _{DS} (on)1	I _D =1A, V _{GS} =4V		170	220	mΩ
	R _{DS} (on)2	I _D =0.5A, V _{GS} =2.5V		190	270	mΩ
Input Capacitance	Ciss	V _{DS} =20V, f=1MHz		325		pF
Output Capacitance	Coss	V _{DS} =20V, f=1MHz		29		pF
Reverse Transfer Capacitance	Crss	V _{DS} =20V, f=1MHz		21		pF
Turn-ON Delay Time	t _d (on)	See specified Test Circuit.		11		ns
Rise Time	t _r	See specified Test Circuit.		17		ns
Turn-OFF Delay Time	t _d (off)	See specified Test Circuit.		40		ns
Fall Time	tf	See specified Test Circuit.		27		ns
Total Gate Charge	Qg	V _{DS} =30V, V _{GS} =4V, I _D =1.8A		4.2		nC
Gate-to-Source Charge	Qgs	V _{DS} =30V, V _{GS} =4V, I _D =1.8A		1.1		nC
Gate-to-Drain "Miller" Charge	Qgd	V _{DS} =30V, V _{GS} =4V, I _D =1.8A		1.1		nC
Diode Forward Voltage	V _{SD}	I _S =1.8A, V _G S=0V		0.84	1.2	V
[SBD]						
Reverse Voltage	VR	IR=200μA	50			V
Forward Voltage	٧F	I _F =500mA		0.5	0.55	V
Reverse Current	IR	V _R =25V			50	μΑ
Interterminal Capacitance	С	V _R =10V, f=1MHz, 1 cycle		17		pF
Reverse Recovery Time	t _{rr}	I _F =I _R =100mA, See specified Test Circuit.			10	ns

Package Dimensions

unit : mm (typ) 7017A-005



Electrical Connection

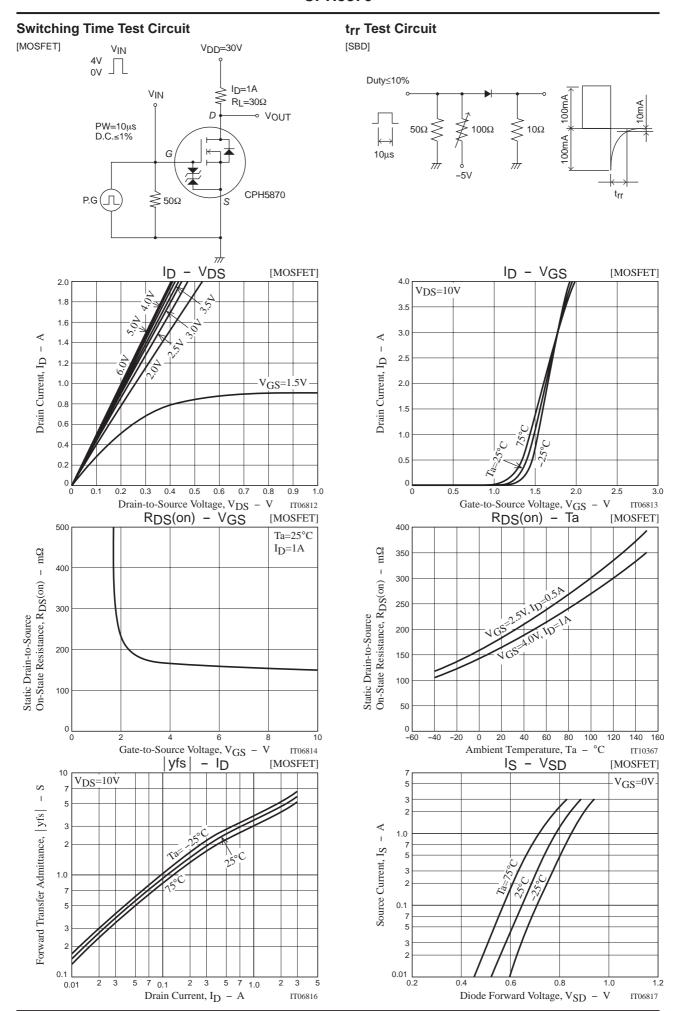


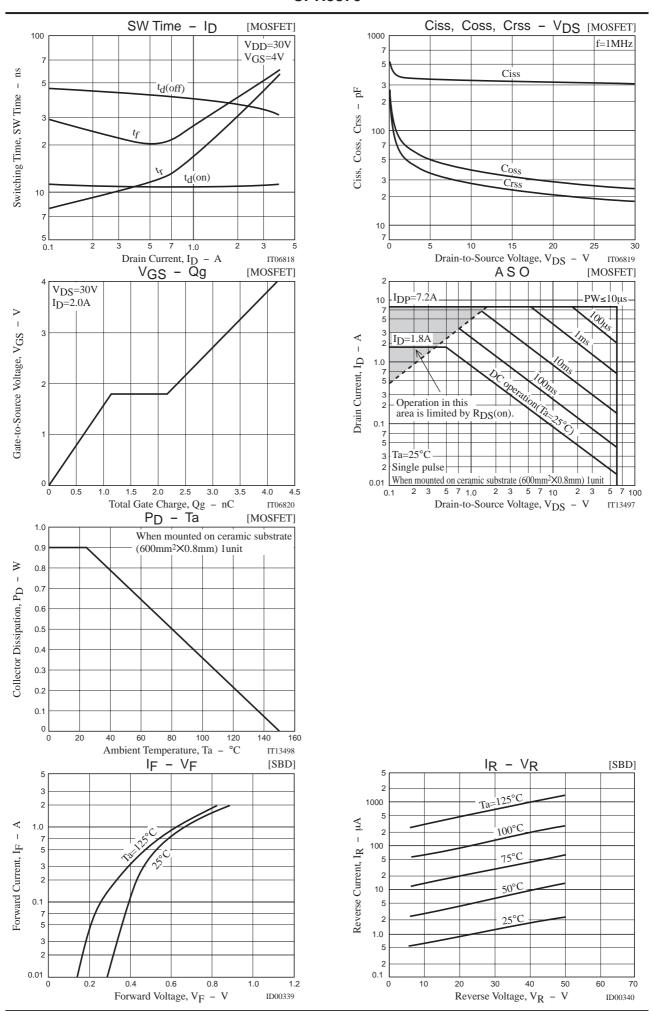
1 : Cathode

2 : Drain 3 : Gate

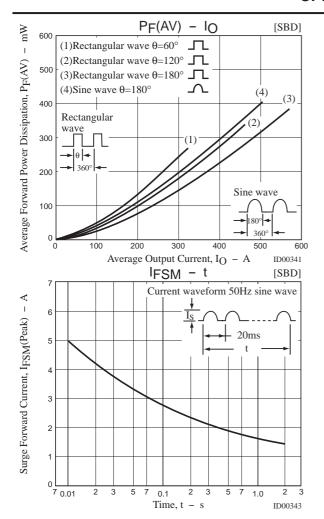
4 : Source 5 : Anode

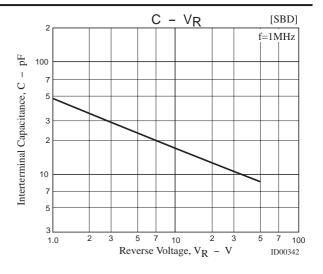
Top view





CPH5870





Note on usage: Since the CPH5870 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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